

Descrição do Produto

Pasta de solda de alta qualidade sem chumbo.

2. Temperatura de armazenamento é 5-10 centígrados.

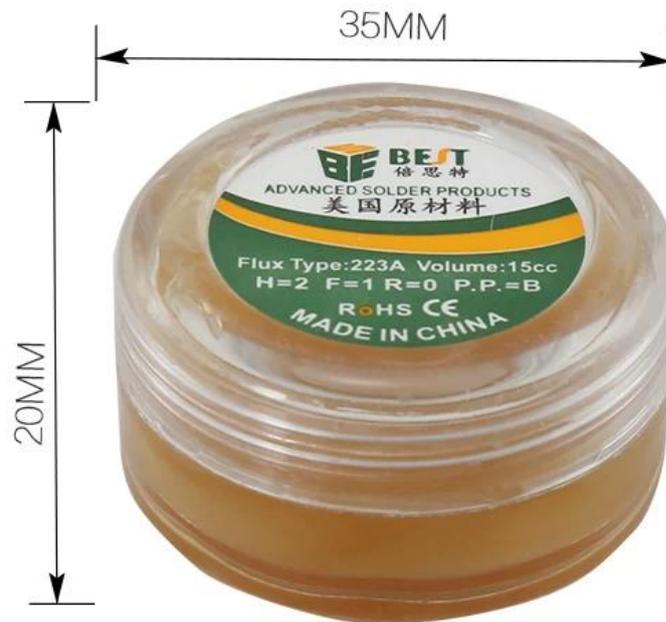
3. Fácil de remover e limpar.

4. made de pó de solda de liga leve de alta qualidade e mistura de fluxo de pasta pré tipo resina.

PRODUCT DISPLAY



PRODUCT DETAILS



Name: solder ing paste

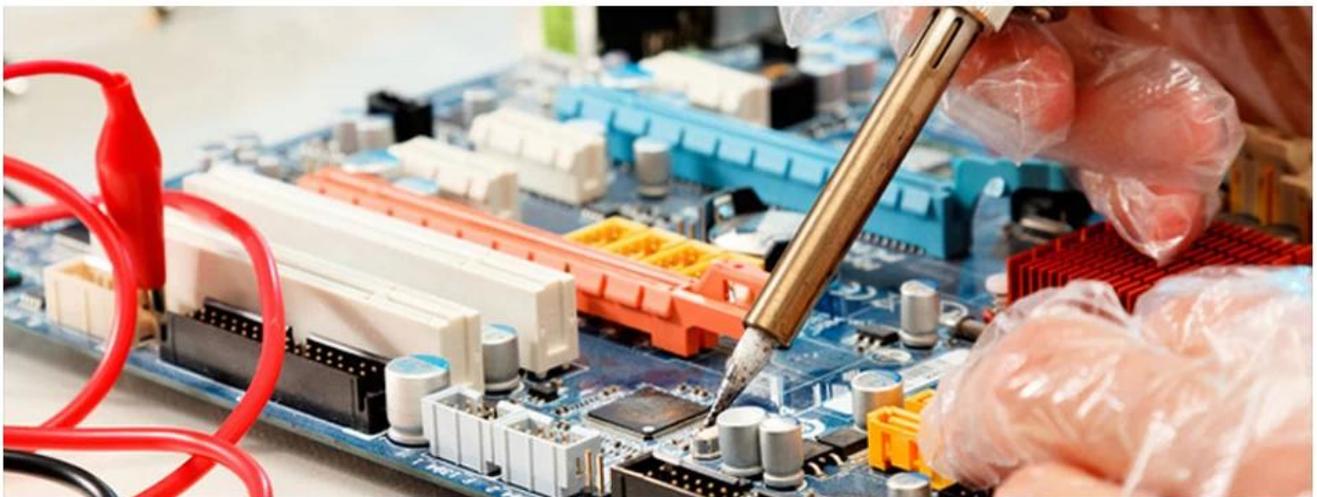
Model: BST-223A

Size: ϕ 35*20mm

Weight: 19.5g

Viscorage: 180 Pa•S

Granularity: 3/ μ m





Storage:Chilled in refrigerator,the best refrigeration temperature is 5°C~10°C.

Feature: 1.Using the USA SMT original material.

2.Made of high quality alloy solder powder and resin type pre paste flux mixture.

3.The fluxing effect is excellent.

4.Easy to remove and clean, environment-friendly and smokeless.

PRODUCT PHOTOGRAPH



